

### Infrared Receiver Module

1-05-08-30

#### Module No.: PIC-2011ASMB-M8D

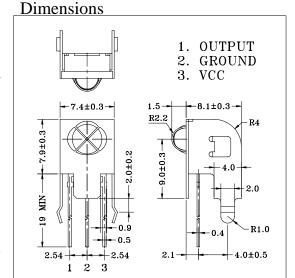
### Strong immunity against noise

#### 1. Features:

- ➤ Miniature size
- ➤ Built-in exclusive IC
- CMOS Design
- Wide half angle & long reception distance
- Good noise-proof capability
- ➤ High immunity against ambient light
- ➤ High protection ability to EMI
- Back Metal Cover
- Side view
- > Mesh
- ➤ Wide voltage operating: 2.7V ~ 5.5V

### 2. Applications

- AV instruments (Audio, TV, VCR, CD player)
- Home appliances (Air-conditioner, Fan, Light.)
- Remote control for wireless devices



(Ta-25°C)

## 3. Absolute Maximum Ratings

J. Absolute Maximum	Kaungs /	(1	19-25 C)
Parameter	Symbol	Ratings	Unit
Supply Voltage	Vec	6.0	V /
Operating Temperature	Topr	-10 ~ +60	°C
Storage Temperature	Tstg	-20 ~ +75	°C
Soldering Temperature *1	Tsol	240	°C

<sup>\*1</sup> At the position of 2mm from the bottom of the package within 5 seconds.

### 4. Electro-optical Characteristics

(Ta=25°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply voltage	Vcc		2.7		5.5	V
Current Consumption	Icc	Input Signal = 0		1.0	1.2	mA
Reception Distance	d	200±5Lux,Vcc=3.0V	10	18		m
Half Angle	$\Delta\theta$			±45		deg
B.P.F. Center Frequency	Fo			37.9		kHz
Peak Wavelength	λр			940		nm
Signal Output	So		Active Low			
High Level Output Voltage	Voh		Vcc-0.3			V
Low Level Output Voltage	Vol				0.25	V
High Level Pulse Width	Twh	Durat Ways - 600us	500	600	700	μs
Low Level Pulse Width	Twl	Burst Wave = $600 \mu s$	500	600	700	μs

### 5. Reliability Test Items

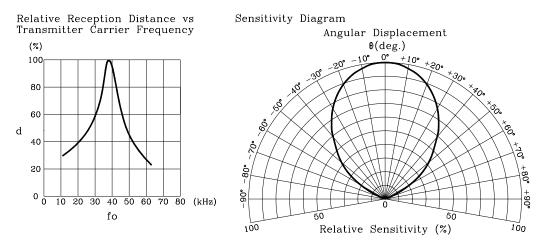
(Ta=25°C)

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Test Items	Test Conditions	Ratings	
High Temperature Storage	Ta=60°C, Vcc=3.0V	t=240hr.	
Low Temperature Storage	Ta=-10°C, Vcc=3.0V	t=240hr.	
High Temperature High Humid Storage	Ta=40°C, 90%RH, Vcc=3.0V	t=240hr.	
Temperature Cycling	-20°C (30min) ~ $+70$ °C (30min)	20 cycles	
Soldering Heat	240±5°C	5 sec.	

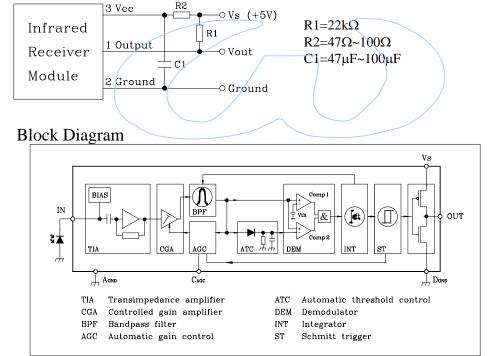


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In case of noisy power supply, please serially insert  $100\Omega$  resistor and about  $47\mu F$  electrolytic capacitor in Vcc line and ground as follows:-



Caution: This device is CMOS design. The signal output port of this device should drive the input port of the next stage device UNILATERALLY. Directly connecting the output port of this device with that of other device is not allowed and will cause the device to be damaged.

#### **Standard Inspection**

Among electrical characteristics, total quantity will be inspected as below:-

- Distance between emitter and detector
- Current consumption
- H level output voltage
- L level output voltage

Standard Transmitter

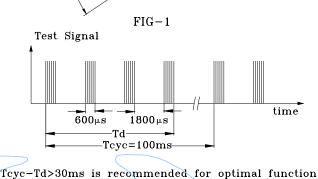
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# **Testing Method**

Distance between emitter and detector specifies maximum distance that output waveform satisfies the standard (FIG-3) under the conditions below against the standard transmitter.

- a. Measuring place
   Indoor without extreme reflection of light.
- b. Ambient light source
  Detecting surface illumination is
  200±5Lux under ordinary white
  fluorescence lamp of no high
  frequency lightning.



Sensing Distance: d

 $\bigcirc$  Vec

 $\bigcirc$  OUT

 $\odot$  GND

c. Standard transmitter

Transmitter wave indicated in

FIG-2 of standard transmitter is

arranged to satisfy Vo≥50mVp-p

under the measuring circuit

specified in FIG-3

Vo Output Signal
Vol Vol Ton Toff

FIG-2

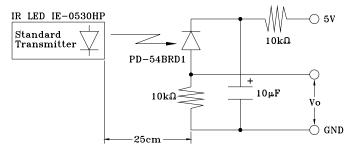


FIG-3 Power Output Measurement Circuit

### Precautions for Use

- a. Store and use where there is no force causing transformation or change in quality.
- b. Store and use where there is no corrosive gas or sea (salt) breeze.
- c. Store and use where there is no extreme humidity.
- d. Solder the lead pin within the condition of ratings. After soldering, do not add exterior force.
- e. Do not wash this device. Wipe the stains of diode side with a soft cloth. You can use the solvent, ethyl alcohol, or methyl alcohol only.
- f. To prevent static electricity damage to the pre-amp, make sure that the human body, the soldering iron are connected to ground before using.